

Number : KSEI-7718/DIR/1026
Attachment : -
Letter Classification : General

October 22, 2026

To: Board of Directors of Account Holders

Indonesia Central Securities Depository (KSEI)

Re: Registration of Indonesia Infrastructure Finance Shelf Registration Bond III Phase II Year 2026

Dear Sir/Madam,

We hereby inform you that PT Indonesia Infrastructure Finance will conduct a Shelf Registration Public Offering through the Indonesia Infrastructure Finance Shelf Registration Bond III, with a fundraising target of Rp6,000,000,000,000 (six trillion Rupiah).

The Bonds that have been previously distributed are as follows:

Securities Name	Distributed Amount	Distribution Date
Indonesia Infrastructure Finance Shelf Registration Bond III Phase I Year 2026	Rp432,585,000,000	July 8, 2026

In connection with the aforementioned shelf registration public offering, the Company will issue and offer the Indonesia Infrastructure Finance Shelf Registration Bond III Phase II Year 2026, with a principal amount of up to Rp1,700,000,000,000 (one trillion seven hundred billion Rupiah), with the following information:

Series	Principal Amount Amount	Coupon Type and Rate (Fixed)	Interest Payment Frequency	Maturity Date	Tenure
A	Rp1,180,965,000,000	7.20 % p.a	Quarterly	November 20, 2027	370 Calendar Days
B	Rp157,105,000,000	7.40 % p.a	Quarterly	November 10, 2029	3 Years
C	Rp361,930,000,000	7.60 % p.a	Quarterly	November 10, 2031	5 Years

The Indonesia Infrastructure Finance Shelf Registration Bond III Phase III and/or subsequent phases (if there are any) will be determined at a later date.

<AAP/Pendaftaran IIFF> | Halaman 1/2

As part of our commitment to Good Corporate Governance, KSEI has implemented an Anti-Bribery Management System applicable to all KSEI personnel. If you become aware of any violations related to this matter, please report them through KSEI's official email address for reporting violations at bit.ly/LaporWBSKSEI.

The Bond's Public Offering Schedule:

Effective Date	:	June 30, 2026
Public Offering Period	:	November 4 – 5, 2026
Allotment Date	:	November 6, 2026
Order Refund Date	:	November 10, 2026
Bond's Electronic Distribution Date	:	November 10, 2026
Listing Date in the Indonesia Stock Exchange	:	November 11, 2026
First Bond Coupon Payment Date	:	February 10, 2027
Bond Lead Underwriters and Underwriters	:	PT BNI Sekuritas PT Aldiracita Sekuritas Indonesia PT BCA Sekuritas PT DBS Vickers Sekuritas Indonesia PT Indo premier Sekuritas PT Mandiri Sekuritas PT Maybank Sekuritas Indonesia PT Mega Capital Sekuritas

Thank you for your kind attention and cooperation.

Sincerely yours,

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Director of Settlement, Custodian Services,
and Surveillance

Yulia Purnama Sari

Head of Custodian Services Division

CC:

1. Board of Commissioners of the Financial Services Authority (OJK) - Attn. Chief Executive Officer for Capital Market Supervision;
2. Indonesia Stock Exchange (IDX);
3. PT Bank CIMB Niaga Tbk as Trustee; and
4. PT Indonesia Infrastructure Finance.